LC898214XD

CMOS LSI AF Controller



Overview

This LSI is AF control LSI. It consists of 1 system of feedback circuit for AF control.

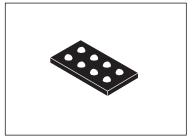
Features

- Built-in equalizer circuit using digital operation
 - AF control equalize circuit
 - Any coefficient can be specified by $I^2C\ I/F$
- I²C Interface
- Built-in A/D converter
 - Maximum 10-bit
 - Input 2 channel
- Built-in D/A converter
 - 8-bit
 - Output 2-channel (Hall offset, Constant current Bias)
- Built-in Hall Sensor
 Si Hall sensor
- Built-in EEPROM
 128 byte (8 byte/page)
- Built-in VGAHall Amp
- Built-in OSC48MHz
- Built-in Constant Current Driver
- Package
 - WL-CSP 8-pin
 - Pb-Free, Halogen Free
- Supply voltage
 - V_{DD} (2.6V to 3.6V)

* I²C Bus is a trademark of Philips Corporation.

ORDERING INFORMATION

See detailed ordering and shipping information on page 9 of this data sheet.



WLCSP8, 1.15x2.37, 0.5P

Pin Description

			TYPE					
Ι	INPUT	Ρ	Power supply, GND	NC	NOT CONNECT			
0	OUTPUT							
В	BIDIRECTION							
■ I ² C in	nterface I2CCK I2CDT	B B	I ² C Clock pin I ² C Data pin					
■ Hall	interface HALL	0	Hall amp output					
■ Drive	er interface							
	OUT1	0	Actuator outpu	ıt pin				
	OUT2	0	Actuator outpu	ıt pin				
■ Powe	er supply pin VDD VSS	P P	Power supply GND					
∎ Test j	pin TEST	0	Test pin					

*Process when pins are not used

PIN TYPE "O" – Ensure that it is set to OPEN. PIN TYPE "I" – OPEN is inhibited. Ensure that it is connected to the VDD or VSS even when it is unused. (Please contact ON Semiconductor for more information about selection of VDD or VSS.)

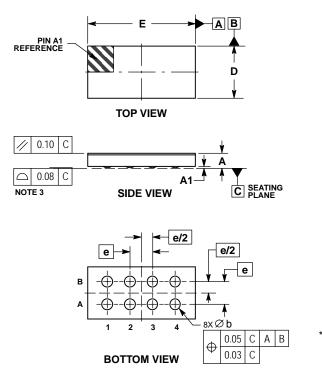
PIN TYPE "B" - If you are unsure about processing method on the pin description of pin layout table, please contact us.

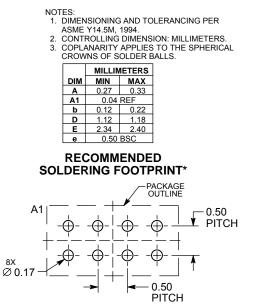
Note that incorrect processing of unused pins may result in defects.

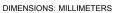
Package Dimensions

unit : mm

WLCSP8, 1.15x2.37, 0.5P CASE 567KL ISSUE A







*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Electrical Characteristics

1) Absolute maximum rating at $V_{SS} = 0V$

Item	Symbol	Condition	Rating	Unit
Supply voltage	V _{DD} 33 max	Ta ≤25°C	–0.3 to 4.6	V
Input/output voltage	V _I 33,V _O 33	Ta ≤25°C	–0.3 to V _{DD} 33+0.3	V
Storage ambient temperature	Tstg		–55 to 125	°C
Operating ambient temperature	Topr		-30 to 70	°C
Continuous output current	lomax	OUT1,OUT2	150	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2) Acceptable operation range at Ta=-30 to $70\ ^{\circ}C,\ V_{SS}=0V$

3V power supply (VDD)

Item	Symbol	Min	Std	Max	Unit
Supply voltage	V _{DD} 33	2.6	2.8	3.6	V
Input voltage range	V _{IN}	0	-	V _{DD} 33	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3) DC characteristics : Input/output level at $V_{SS} = 0V$, $V_{DD} = 2.6V$ to 3.6V, Ta = -30 to 70 °C

Item	Symbol	Condition	Min	Std	Max	Unit	Applicable pins
High-level input voltage	VIH	CMOS compliant	1.4			V	
Low-level input voltage	VIL	Schmidt			0.4	V	I2CCK, I2CDT,
Low-level output voltage	VOL	IOL= 2mA			0.4	V	I2CDT

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4) Driver output (OUT1, OUT2) at $V_{SS} = 0V$, $V_{DD} = 2.8V$, Ta = 25 °C

Item	Symbol	Condition	Min	Std	Max	Unit	Applicable pins
Maximum current	lfull		108		137	mA	
Output ON resistance	Ronu	lo=120mA Pch		2.8		Ω	
Compliance voltage	Vcomp		0.5			V	OUT1, OUT2
Output leak current	loleak			1		μA	
Diode forward voltage	VD	ID=-120mA		0.9		V	

Actuator resistance (Ract) = (VM-(Ronu*lo+Vcomp)) / lo $[\Omega]$

5) Non-volatile Memory Characteristics

Item	Symbol	Condition	Min	Std	Max	Unit	Applicable pins	
Endurance	EN				1000	Cycles	FORDOM	
Data retention	RT		10			Years	E2PROM	

Hall element position

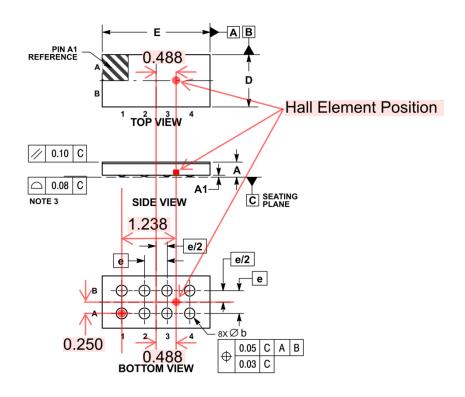


Figure 1 : Hall element position

Please refer to package diagram for each dimension.

AC Characteristics

V_{DD} supply timing

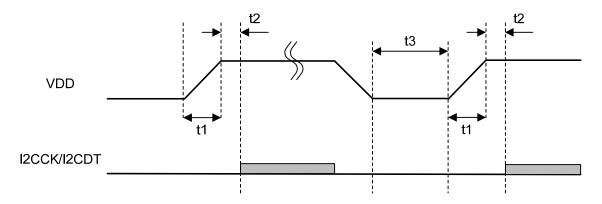


Figure 2 : V_{DD} supply timing

It is available to use I^2C 2ms later for Power On Reset of $V_{\mbox{DD}}.$

Item	Symbol	Min	Тур	Max	Unit
VDD turn on time	t1			3	ms
I ² C start time from VDD on	t2	2			ms
VDD off time	t3	10			ms

AC specification

Figure 2 shows interface timing definition and Table 1 shows electric characteristics.

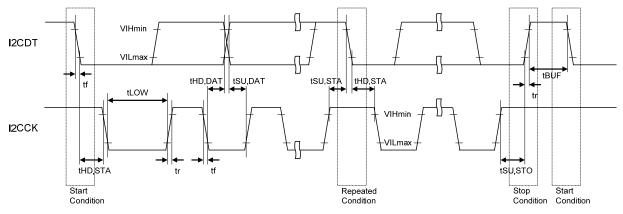


Figure 3 : I²C interface timing definition

Item	Symbol	Pin name	Min	Тур	Max	Unit
I2CCK clock frequency	Fi2cck	I2CCK			400	kHz
START condition hold time	tHD,STA	I2CCK I2CDT	0.6			μS
I2CCK clock Low period	tLOW	I2CCK	1.3			μS
I2CCK clock High period	tHIGH	I2CCK	0.6			μS
Setup time for repetition START condition	tSU,STA	I2CCK I2CDT	0.6			μS
Data hold time	tHD,DAT	I2CCK I2CDT	0 (*)		0.9	μS
Data setup time	tSU,DAT	I2CCK I2CDT	100			ns
I2CDT, I2CCK rising time	tr	I2CCK I2CDT			300	ns
I2CDT, I2CCK falling time	tf	I2CCK I2CDT			300	ns
STOP condition setup time	tSU,STO	I2CCK I2CDT	0.6			μS
Bus free time between STOP and START	tBUF	I2CCK I2CDT	1.3			μS

 Table 1 : Electric characteritics for I²C interface (AC characteristics)

* : Although the I²C specification defines a condition that 300 ns of hold time is required internally, LC898214XD is designed for a condition with typ. 20 ns of hold time. If I2CDT signal is unstable around falling point of I2CCK signal, please implement an appropriate treatment on board, such as inserting a resistor.

ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
LC898214XD-MH	WLCSP8, 1.15x2.37, 0.5P (Pb-Free / Halogen Free)	5000 / Tape & Reel

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